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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/752,642	01/07/2004	Naofumi Nakamura	790001-2042	4109
20999	7590 11/02/2006		EXAMINER	
FROMMER LAWRENCE & HAUG			FENTY, JESSE A	
,	VENUE- 10TH FL. , NY 10151		ART UNIT	PAPER NUMBER
1,2 10141	,		2815	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)
	10/752,642	NAKAMURA ET AL.
Office Action Summary	Examiner	Art Unit
· · · · · · · · · · · · · · · · · · ·	Jesse A. Fenty	2815
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period was preply repeated by the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be will apply and will expire SIX (6) MONTHS from the application to become ABANDOI	ON. timely filed om the mailing date of this communication. NED (35 U.S.C. § 133).
Status		
Responsive to communication(s) filed on <u>17 At</u> This action is FINAL . 2b) ☐ This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, p	•
Disposition of Claims		
 4) ☐ Claim(s) 1-14 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) 7-10,13 and 14 is/are allowed. 6) ☐ Claim(s) 1-3,5,6,11 and 12 is/are rejected. 7) ☐ Claim(s) 4 is/are objected to. 8) ☐ Claim(s) are subject to restriction and/o 	vn from consideration.	
Application Papers		
9) The specification is objected to by the Examine	ır.	
10) ☐ The drawing(s) filed on is/are: a) ☐ acc		e Examiner.
Applicant may not request that any objection to the	drawing(s) be held in abeyance. S	See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex		· ·
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1 Certified copies of the priority document 2 Certified copies of the priority document 3 Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applic rity documents have been rece u (PCT Rule 17.2(a)).	ation No ived in this National Stage
•		
Attachment(e)		
Attachment(s) 1) Notice of References Cited (PTO-892)	4) 🔲 Interview Summ	ary (PTO-413)
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/Mail	

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 2, 3, 5, 6, 11 and 12 are rejected under 35 U.S.C. 102(e) as being anticipated by Iwasaki et al. (US 2002/0167091 A1).

In re claim 1, Iwasaki (e.g., Fig. 1) discloses a semiconductor device, comprising: at least two wiring layers (19, 15);

a via contact (17) formed between the at least two layers and made of a metal wiring material (aluminum plus copper) which is the same as that of the at least two wiring layers,

wherein the metal wiring material of the via contact contains an additive (copper and nickel or silicon – page 2, paragraph [0027]) which is not contained in the metal wiring materials of the at least two wiring layers.

In re claim 2, Iwasaki discloses the device of claim 1, wherein the metal wiring material comprises copper and the additive is Nickel.

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In re claim 3, Iwasaki discloses the device of claim 1, wherein the metal wiring material is AL and the additive is Cu or Si.

In re claim 5, Iwasaki (e.g., Fig. 1) discloses a semiconductor device, comprising: at least two wiring layers (19, 15);

a via contact (17) formed between the at least two layers and made of a metal wiring material (aluminum plus copper) which is the same as that of the at least two wiring layers,

wherein metal wiring materials of the at least two wiring layers contain at least one additive, and a metal wiring material of the via contact contains at least two additives which include an additive which is the same (copper) as that contained in the metal wiring materials of the at least two wiring layers and the at least two wiring layers and an additive which is not contained in the metal wiring materials of the at least two wiring layers (see pp. 4, last 9 lines of paragraph [0037]).

In re claim 6, Iwasaki discloses the device of claim 5, wherein the metal wiring material comprises copper and the additive is Ni.

In re claim 11, Iwasaki discloses a semiconductor device, comprising:

a first metal wiring layer (15) made of a first wiring material, formed in a first wiring groove formed in a first insulating film (13) on a semiconductor substrate (1),

a second insulating film (18) on the first insulating film having the first wiring layer embedded therein,

a via contact (17) embedded in a via hole formed in the second insulating film, the via contact being made of the same wiring material as the first wiring material, which

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contain an additive (Ni or Si) which is not contained in the first wiring material of the first wiring layer,

a third insulating film (21) on the second insulating film having the via contact formed therein; and

a second metal wiring layer (19) embedded in a second wiring groove formed in the third insulating film, the second metal wiring layer being made of the same metal wiring material as the metal wiring material of the first metal wiring layer.

In re claim 12, Iwasaki discloses the device of claim 11, wherein the metal wiring material comprises copper and the additive is Ni.

Allowable Subject Matter

Claim 4 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claims 7 – 10, 13 and 14 are allowed.

Response to Arguments

Applicant's arguments filed 08/17/06 have been fully considered but they are not persuasive.

In the Remarks, applicant does not directly address the merits of examiner's rejection. Instead, applicant re-interprets the prior art lwasaki disclosure such that the

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layers (17 and 23) are designated the wiring layers instead of the examiner designated layers (15 and 19).

Examiner points out, for clarity in this instance, that the claims are being interpreted broadly, as in accordance with patent office procedure. To that end, the term, "wiring layers" is interpreted broadly. Unless applicant can show that "wiring" is afforded a special meaning in the specification or in the art, a via conductor will not be interpreted to have a different structure than a wiring, only the orthogonal orientation may be different.

Likewise, wiring layers may be said to comprise several layers in one. Therefore, in this instance, the outer layers (15 and 19) are as much a part of the wiring "layers" as is the inner conductors (17, 20 or 23) because they combine to form one layer.

Since Iwasaki is the main reference cited in the rejection, all other arguments stem from this argument and can be referenced hereto.

Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later. than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jesse A. Fenty whose telephone number is 571-272-1729. The examiner can normally be reached on 5/4-9 1st Fri. Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on 571-272-1664. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Jesse A. Fenty Examiner Art Unit 2815

JAF